

# 2.5 mm x 3.2 mm Ceramic Package SMD Oscillator, TTL / HC-MOS



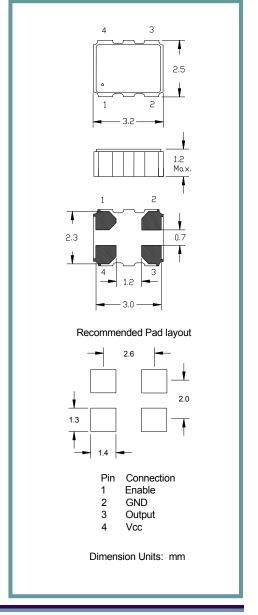
### **Product Features:**

Low Jitter, Non-PLL Based Output CMOS/TTL Compatible Logic Levels Compatible with Leadfree Processing

# **Applications:**

Fibre Channel Server & Storage Sonet /SDH 802.11 / Wifi T1/E1, T3/E3 System Clock

Frequency	1.000 MHz to 152.250 MHz					
Output Level						
HC-MOS	'0' = 0.1 Vcc Max., '1' = 0.9 Vcc Min.					
TTL	'0' = 0.4 VDC Max., '1' = 2.4 VDC Min.					
Duty Cycle	Specify 50% ±10% or ±5% See Table in Part Number Guide					
Rise / Fall Time	6 nS Max.					
Output Load	See Table in Part Number Guide					
Frequency Stability	See Frequency Stability Table (Includes room temperature tolerance and stability over operating temperature)					
Start-up Time	10 mS Max.					
Enable / Disable Time	100 nS Max. N.C. or ≥ 70% Vdd = Enable. ≤ 30% Vdd = Disable.					
Supply Voltage	See Input Voltage Table, tolerance ±5 %					
Current	25 mA Max. (5.0V)					
	20 mA Max. (1.8V-3.3V)					
Operating	See Operating Temperature Table in Part Number Guide					
Storage	-55° C to +125° C					
Jitter: RMS(1sigma)						
1 MHz-60 MHz	5 pS RMS (1 sigma) Max. accumulated jitter (20K adjacent periods)					
Max Integrated	1.5 pS RMS (1 sigma -12KHz to 20MHz)					
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Max Total Jitter 1 MHz-60 MHz	50 pS p-p (100K adjacent periods)					



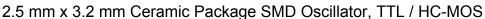
Part Number Guide		Sample Part Number: ISM97 - 3251BH - 20.000			- 20.000		
Package	Input Voltage	Operating Temperature	Symmetry (Duty Cycle)	Output	Stability (in ppm)	Enable / Disable	Frequency
	5 = 5.0 V	1 = 0° C to +70° C	5 = 45 / 55 Max.	1 = 10TTL / 15 pF HC-MOS	**E = ±10	H = Enable	
ISM97 -	3 = 3.3 V	6 = -10° C to +70° C	6 = 40 / 60 Max.	6 = 30 pF	**D = ±15	O = N/C	
	7 = 3.0 V	3 = -20° C to +70° C		5 = 50 pF HC-MOS (<40 MHz)	**F = ±20		00 000 MH-
	2 = 2.7 V	4 = -30° C to +75° C			**A = ±25		- 20.000 MHz
	6 = 2.5 V	2 = -40° C to +85° C			B = ±50		
	1 = 1.8 V*				C = ±100		

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NOTE: A 0.01 µF bypass capacitor is recommended between Vcc (pin 4) and GND (pin 2) to minimize power supply noise.

\* Not available at all frequencies. \*\* Not available for all temperature ranges. \*\*\* Frequency, supply, and load related parameters.

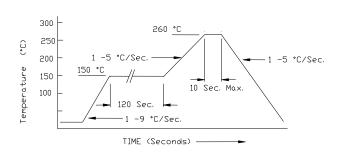






## Pb Free Solder Reflow Profile:

# **Typical Application:**



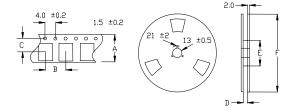


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# **Package Information:**

MSL = N.A. (package does not contain plastic; storage life is unlimited under normal room conditions. Termination = e4 (Au over Ni over W base metalization.

# **Tape and Reel Information:**



Quantity per Reel	3000
Α	8.0 +/2
В	4.0 +/2
С	5.5 +/1
D	9.0 +/-1
E	50 / 60 / 80
F	180

# **Environmental Specifications**

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition B
Mechanical Vibration	MIL-STD-883, Method 2007, Condition A
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS / Green Compliant
Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s
Solvent Resistance	MIL-STD-202, Method 215

## Marking

Line 1: ILSI, Date Code (YWW)

Line 2: Frequency

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